

PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	ADG/22/13757	
1.3 Title of PCN	DPAK Automotive AI wire line relocation from Shenzhen to Tongfu Microelectronics (China)	
1.4 Product Category	Power MOSFET HV	
1.5 Issue date	2022-11-07	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Maurizio GIUDICE
2.1.2 Marketing Manager	Paolo PETRALI
2.1.3 Quality Manager	Vincenzo MILITANO

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	Shenzhen (China)

4. Description of change

	Old	New
4.1 Description	DPAK Automotive AI wire products are manufactured in Shenzhen (China)	DPAK Automotive AI wire products are manufactured in Tongfu Microelectronics (China)
4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?	no impact	

5. Reason / motivation for change

5.1 Motivation	DPAK AI wire Automotive Line Shenzhen closure
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	By internal traceability and dedicated FG code
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7. Timing / schedule

7.1 Date of qualification results	2022-11-03
7.2 Intended start of delivery	2023-05-08
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	13757 RERPTD22094_2.0_Power Mosfet High Voltage DPAK Automotive Transfer from STS to TFME.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2022-11-07

9. Attachments (additional documentations)

13757 Public product.pdf
13757 DPAK Automotive AI wire line relocation from Shenzhen to TFME.pdf
13757 RERPTD22094_2.0_Power Mosfet High Voltage DPAK Automotive Transfer from STS to TFME.pdf
13757 PCN-FORM-Rev_4_0 Conti.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STD10NF30	
	STD12N60DM2AG	
	STD14NM50NAG	
	STD15N50M2AG	
	STD18NF25	
	STD4NK100Z	
	STD5NM50AG	
	STD7ANM60N	
	STD8NF25	



Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title : DPAK Automotive AI wire line relocation from Shenzhen to Tongfu Microelectronics (China)

PCN Reference : ADG/22/13757

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

STD7N95K5AG	STD9NM50N	STD12N60DM2AG
STD4NK100Z	STD18NF25	STD7ANM60N
STD9N65DM6AG	STD10NF30	STD8NF25
STD14NM50NAG	STD15N50M2AG	STD5NM50AG
STD13N50DM2AG		



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